Low switching losses
Low reverse recovery charge
High power cycling capability

Fast Recovery Diode
Type DF373-2000-36

Average forward current		I_{FAV}	2000 A	
Repetitive peak reverse voltage		V_{RRM}	3000...3600 V	
Reverse recovery time		t_{rr}	16.0 μs	
V_{RRM}, V	3000	3200	3400	3600
Voltage code	30	32	34	36
T_j, °C	–60...+125			

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{FAV}	Maximum allowable average forward current	A	2000 3215	T_c=90 °C; Double side cooled; T_c=55 °C; Double side cooled; 180° half-sine wave; 50 Hz	
I_{FRMS}	RMS forward current	A	3140	T_c=90 °C; Double side cooled; 180° half-sine wave; 50 Hz	
I_{FSM}	Surge forward current	kA	50.0 57.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=10 ms; single pulse; V_R=0 V;
			53.0 61.0	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=8.3 ms; single pulse; V_R=0 V;
I^2t	Safety factor	$A^2s\cdot10^3$	12500 16200	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=10 ms; single pulse; V_R=0 V;
			11600 15400	T_j=$T_{j\,max}$ T_j=25 °C	180° half-sine wave; t_p=8.3 ms; single pulse; V_R=0 V;
BLOCKING					
V_{RRM}	Repetitive peak reverse voltages	V	3000...3600	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; 50 Hz;	
V_{RSM}	Non-repetitive peak reverse voltages	V	3100...3700	$T_{j\,min}$< T_j <$T_{j\,max}$; 180° half-sine wave; single pulse;	
V_R	Reverse continuous voltages	V	0.6·V_{RRM}	T_j=$T_{j\,max}$;	
THERMAL					
T_{stg}	Storage temperature	°C	–60...+55		
T_j	Operating junction temperature	°C	–60...+125		
MECHANICAL					
F	Mounting force	kN	40.0...50.0		
a	Acceleration	m/s^2	50	Device clamped	

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{FM}	Peak forward voltage, max	V	2.10	T_j=25 °C; I_{FM}=6280 A	
$V_{F(TO)}$	Forward threshold voltage, max	V	1.230	T_j=$T_{j\ max}$; 0.5 π I_{FAV} < I_T < 1.5 π I_{FAV}	
r_T	Forward slope resistance, max	mΩ	0.169		
BLOCKING					
I_{RRM}	Repetitive peak reverse current, max	mA	200	T_j=$T_{j\ max}$; V_R=V_{RRM}	
SWITCHING					
Q_r	Recovered charge, max	μC	5000	T_j=$T_{j\ max}$; I_{FM}=1000 A; di_R/dt=-100 A/μs; V_R=100 V;	
t_{rr}	Reverse recovery time[1)], max	μs	16.0		
I_{rr}	Reverse recovery current, max	A	620		
THERMAL					
R_{thjc}	Thermal resistance, junction to case, max	°C/W	0.0085	Direct current	Double side cooled
R_{thjc-A}			0.0187		Anode side cooled
R_{thjc-K}			0.0153		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max	°C/W	0.0020	Direct current	
MECHANICAL					
m	Weight, max	g	1160		
D_s	Surface creepage distance	mm (inch)	41.40 (1.630)		
D_a	Air strike distance	mm (inch)	23.10 (0.909)		

PART NUMBERING GUIDE

DF	373	2000	36	T3	N
1	2	3	4	5	6

1. Fast recovery diode
2. Design version
3. Average forward current, A
4. Voltage code
5. Group of reverse recovery time
6. Ambient conditions: N – normal; T – tropical

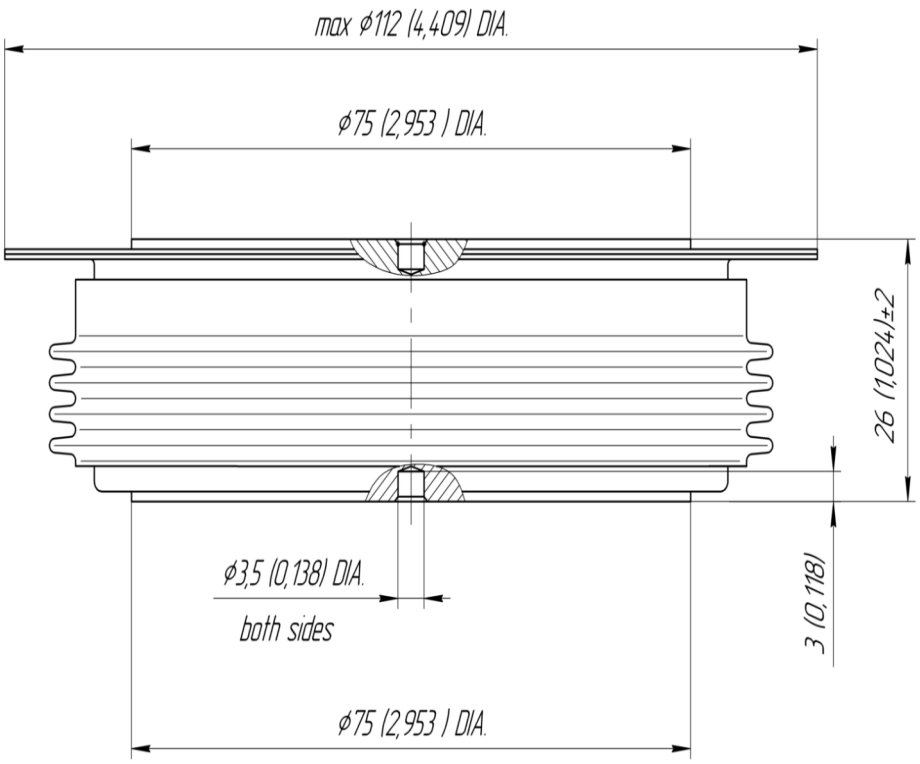
NOTES

[1)] Reverse recovery time

Group Symbol	T3
t_{rr}, μs	16.0

OVERALL DIMENSIONS

Package type: D.F1



All dimensions in millimeters (inches)

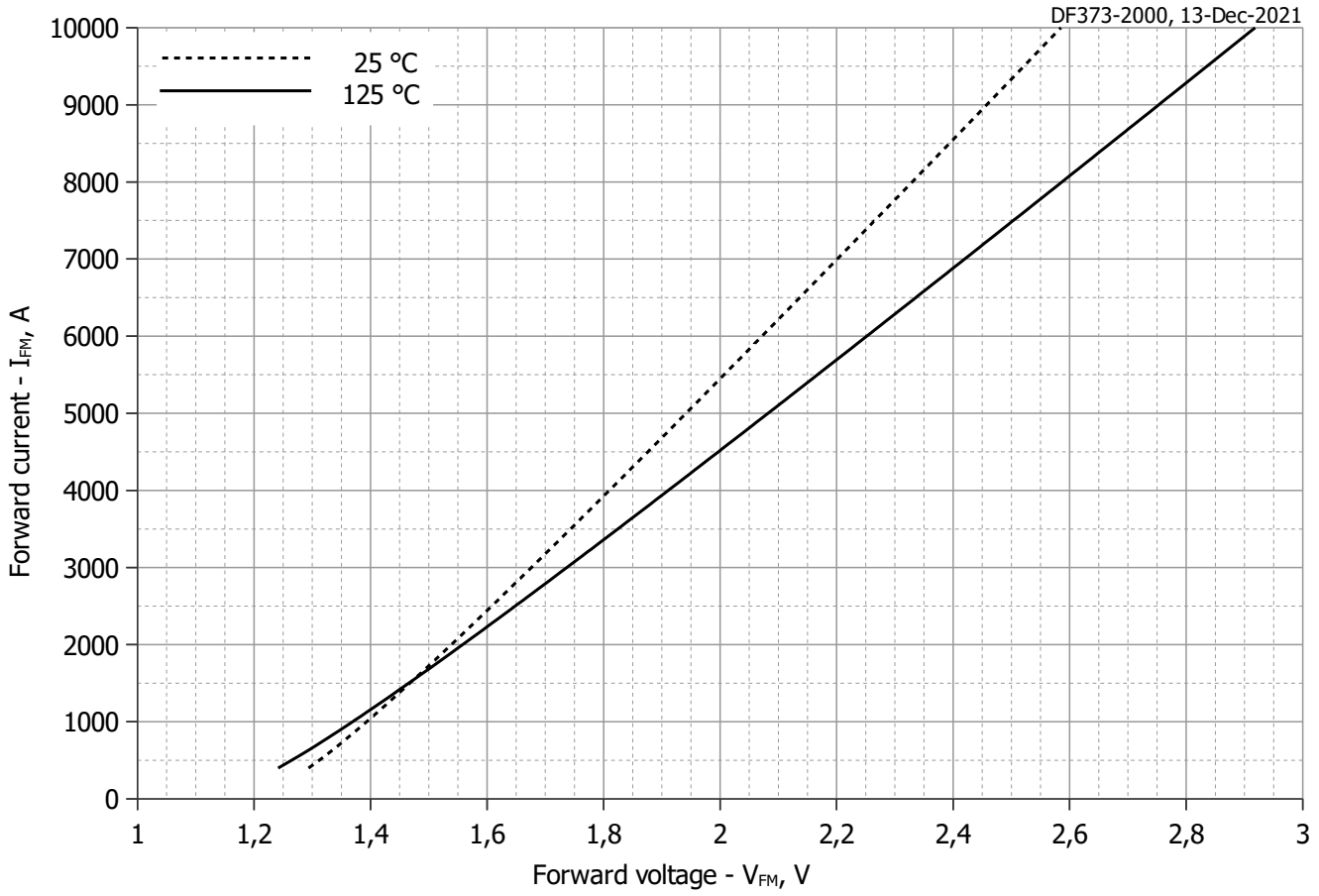


Fig 1 – Forward characteristics of Limit device

Analytical function for Forward characteristic:

$$V_F = A + B \cdot i_F + C \cdot \ln(i_F + 1) + D \cdot \sqrt{i_F}$$

	Coefficients for max curves	
	T_j = 25°C	$T_j = T_{j\,max}$
A	1.12484035	1.05135431
B	0.00012033	0.00015445
C	0.01670098	0.01537457
D	0.00103067	0.00180721

Forward characteristic model (see Fig. 1).

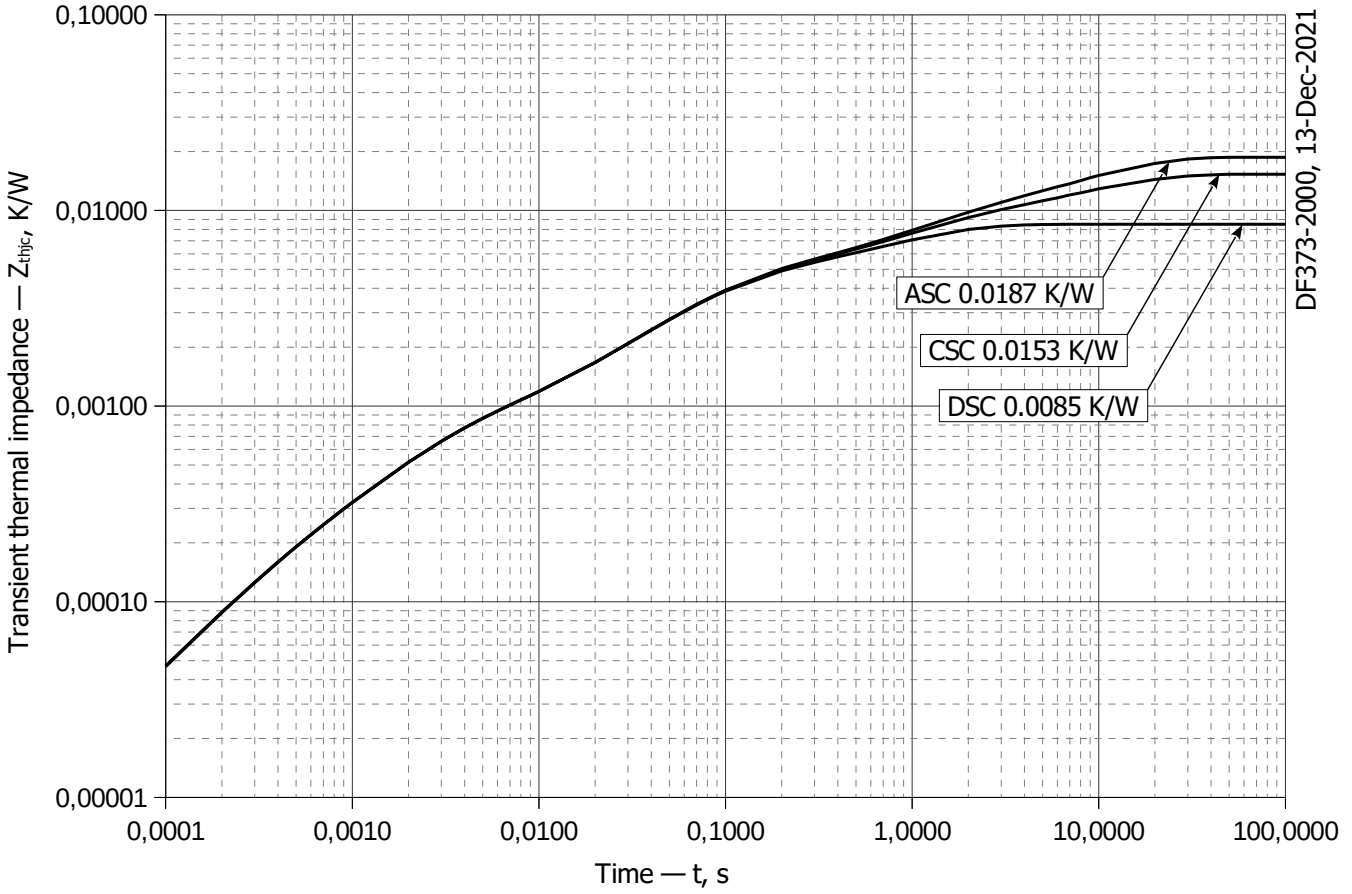


Fig 2 – Transient thermal impedance Z_{thjc} vs. time t

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^{n} R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where ***i*** = 1 to ***n***, ***n*** is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t.

R_i = Amplitude of p_{th} term.

τ_i = Time constatnt of r_{th} term.

DC Double side cooled

i	1	2	3	4	5	6
R_i, K/W	0.00007989	0.002973	0.0005936	0.000846	0.00005975	0.003948
τ_i, s	1.688	0.06219	0.002329	0.138	0.0003243	0.9533

DC Cathode side cooled

i	1	2	3	4	5	6
R_i, K/W	0.006819	0.004034	0.0008595	0.002956	0.0005965	0.00005689
τ_i, s	9.744	1.025	0.1394	0.06237	0.002318	0.0003037

DC Anode side cooled

i	1	2	3	4	5	6
R_i, K/W	0.01023	0.004062	0.0009401	0.002853	0.0005963	0.00005641
τ_i, s	9.747	1.058	0.1304	0.06179	0.002313	0.0003013

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

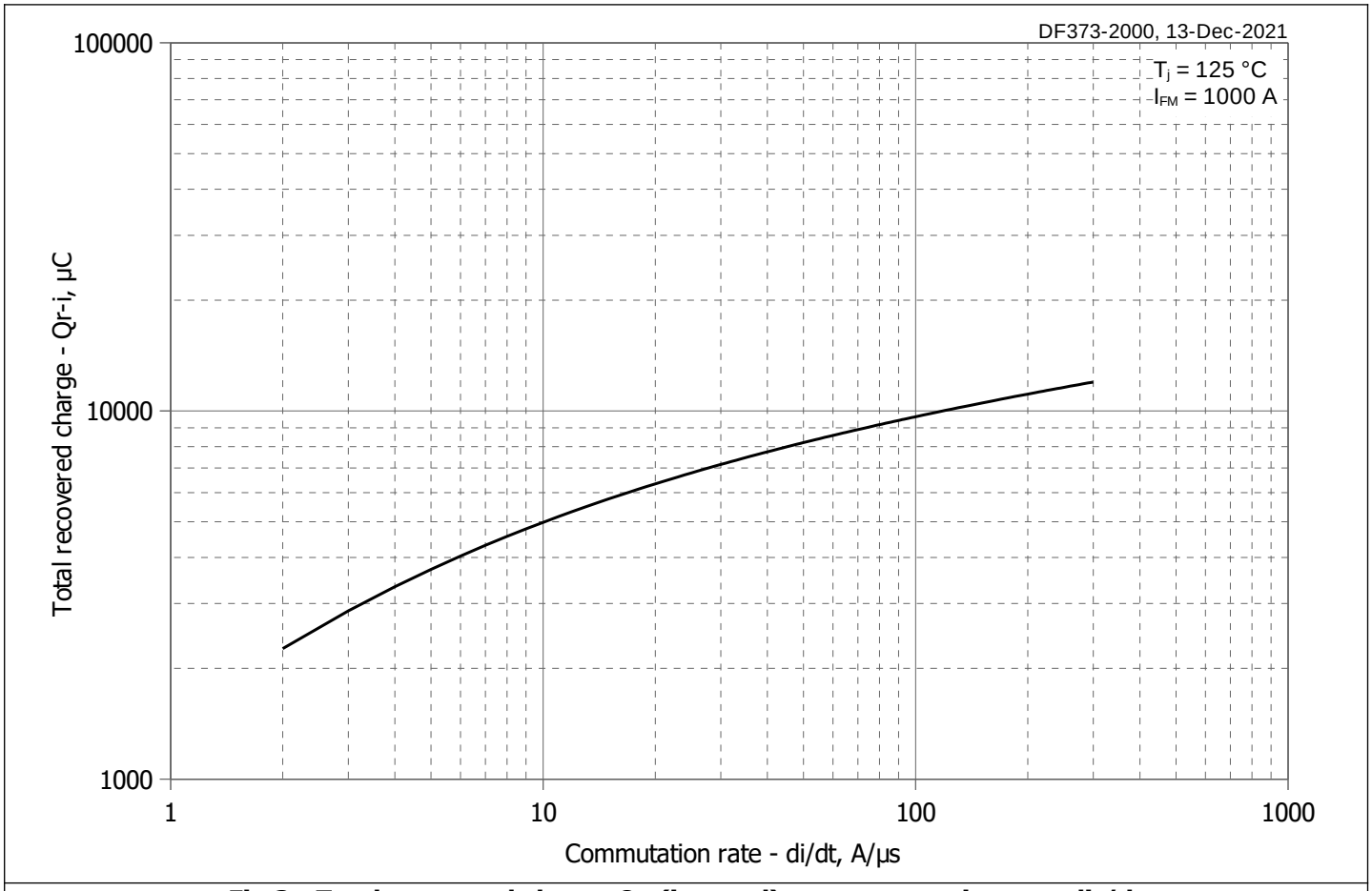


Fig 3 - Total recovered charge Q_{r-i} (integral) vs. commutation rate di_R/dt

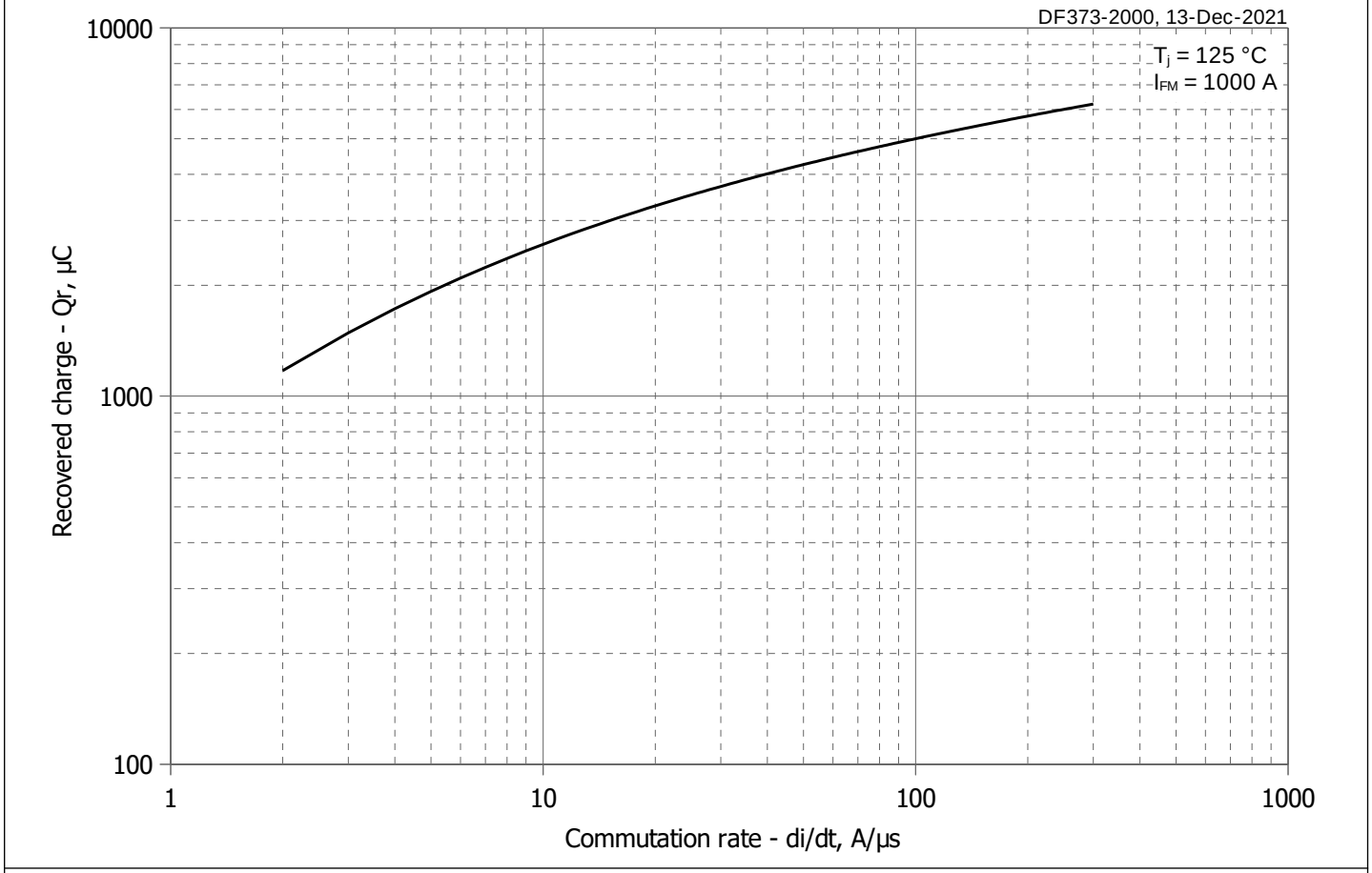


Fig 4 - Maximum recovered charge Q_r vs. commutation rate di_R/dt (50% chord)

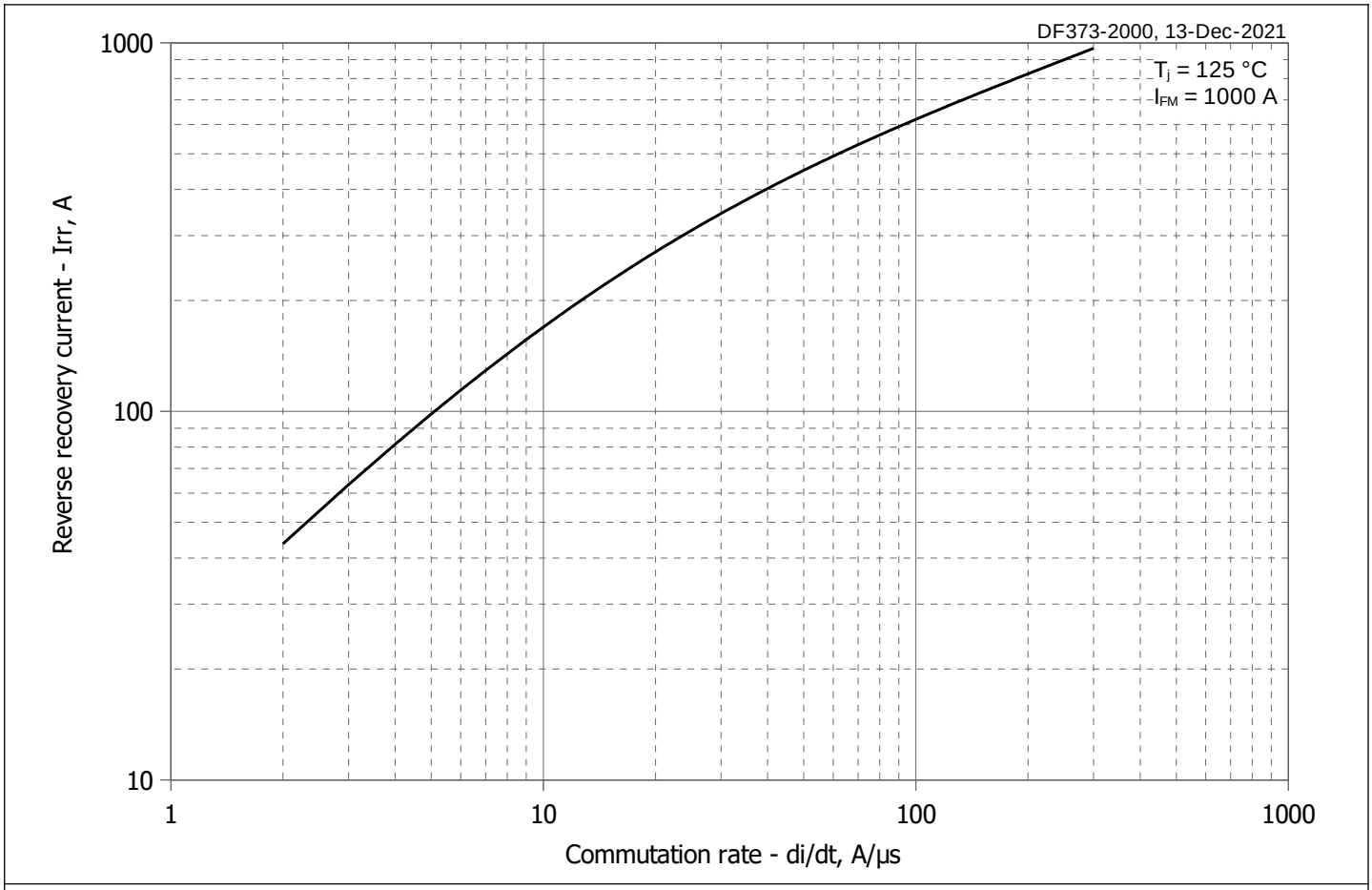


Fig 5 - Maximum reverse recovery current I_{rr} vs. commutation rate di_R/dt

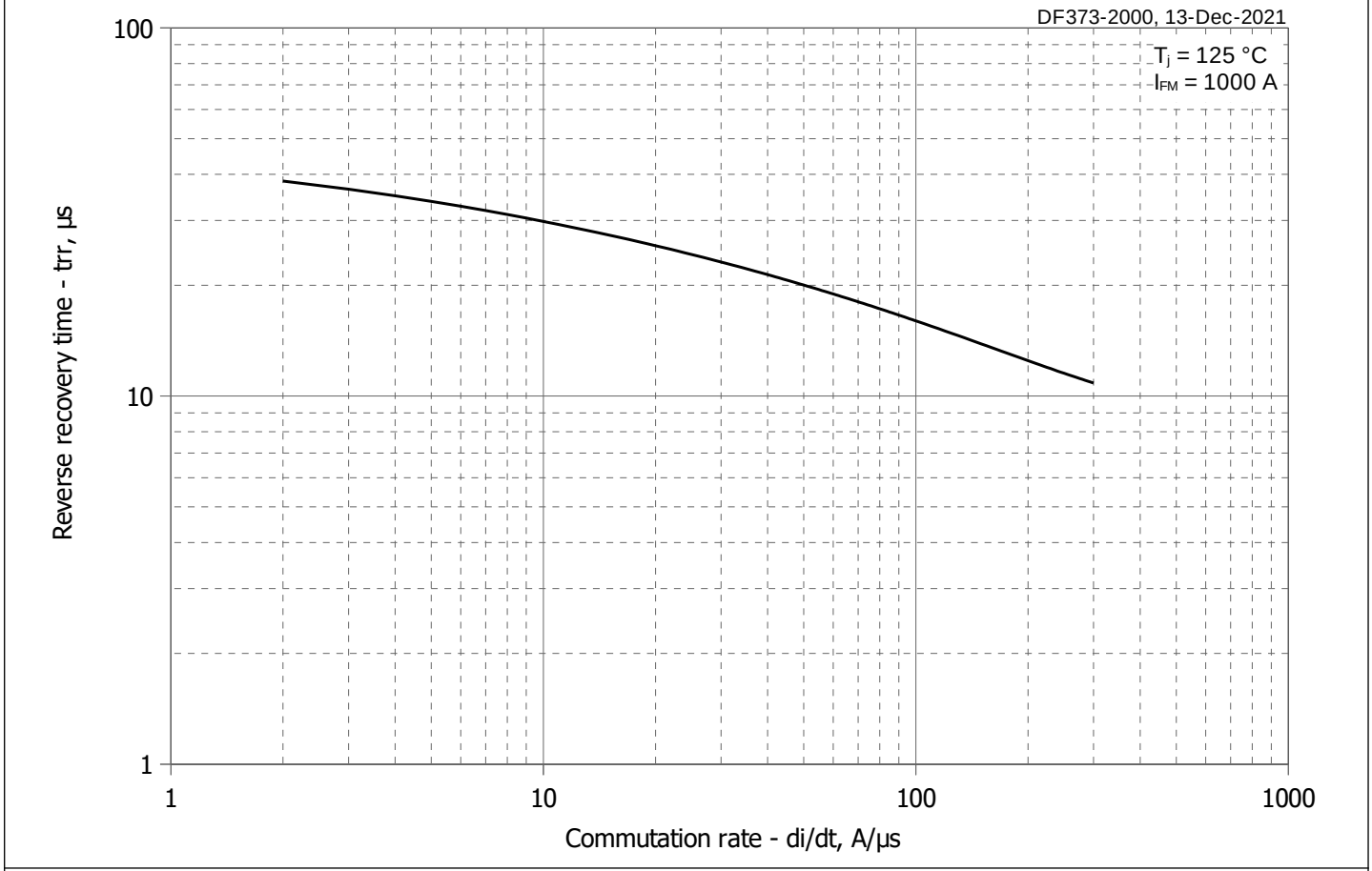


Fig 6 - Maximum recovery time t_{rr} vs. commutation rate di_R/dt (50% chord)

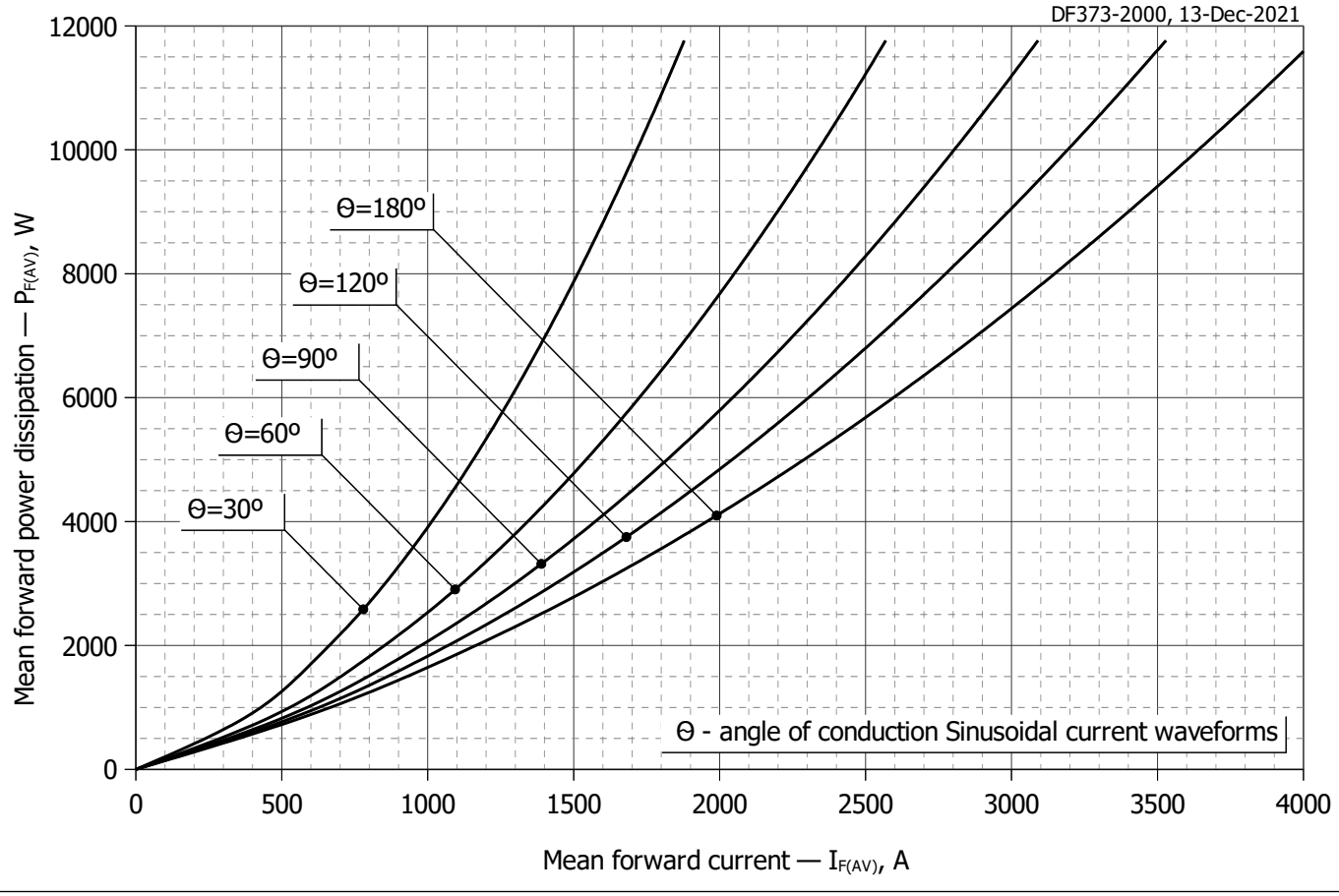


Fig. 7 - Mean forward power dissipation P_{FAV} vs. mean forward current I_{FAV} for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

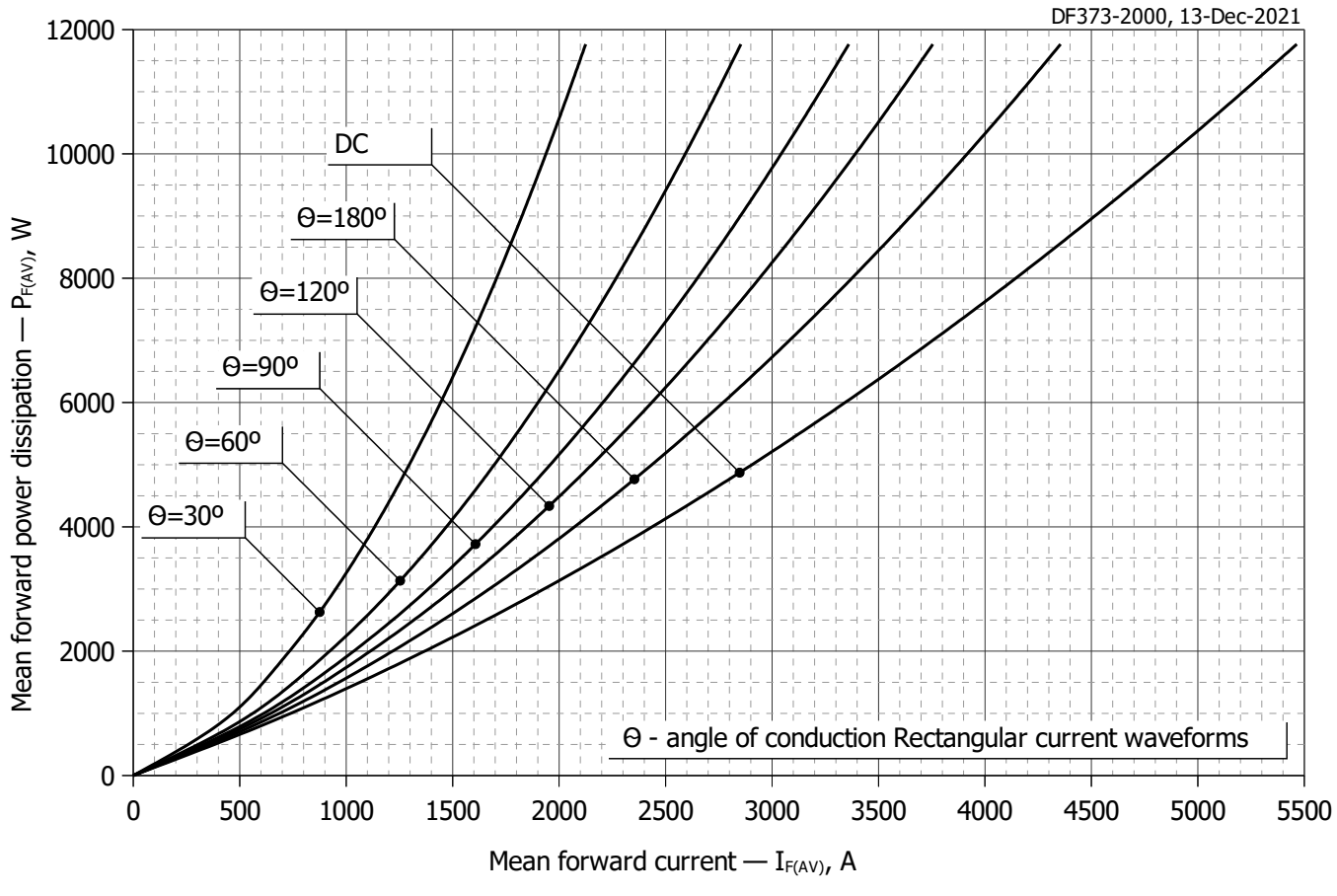


Fig. 8 – Mean forward power dissipation P_{FAV} vs. mean forward current I_{FAV} for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

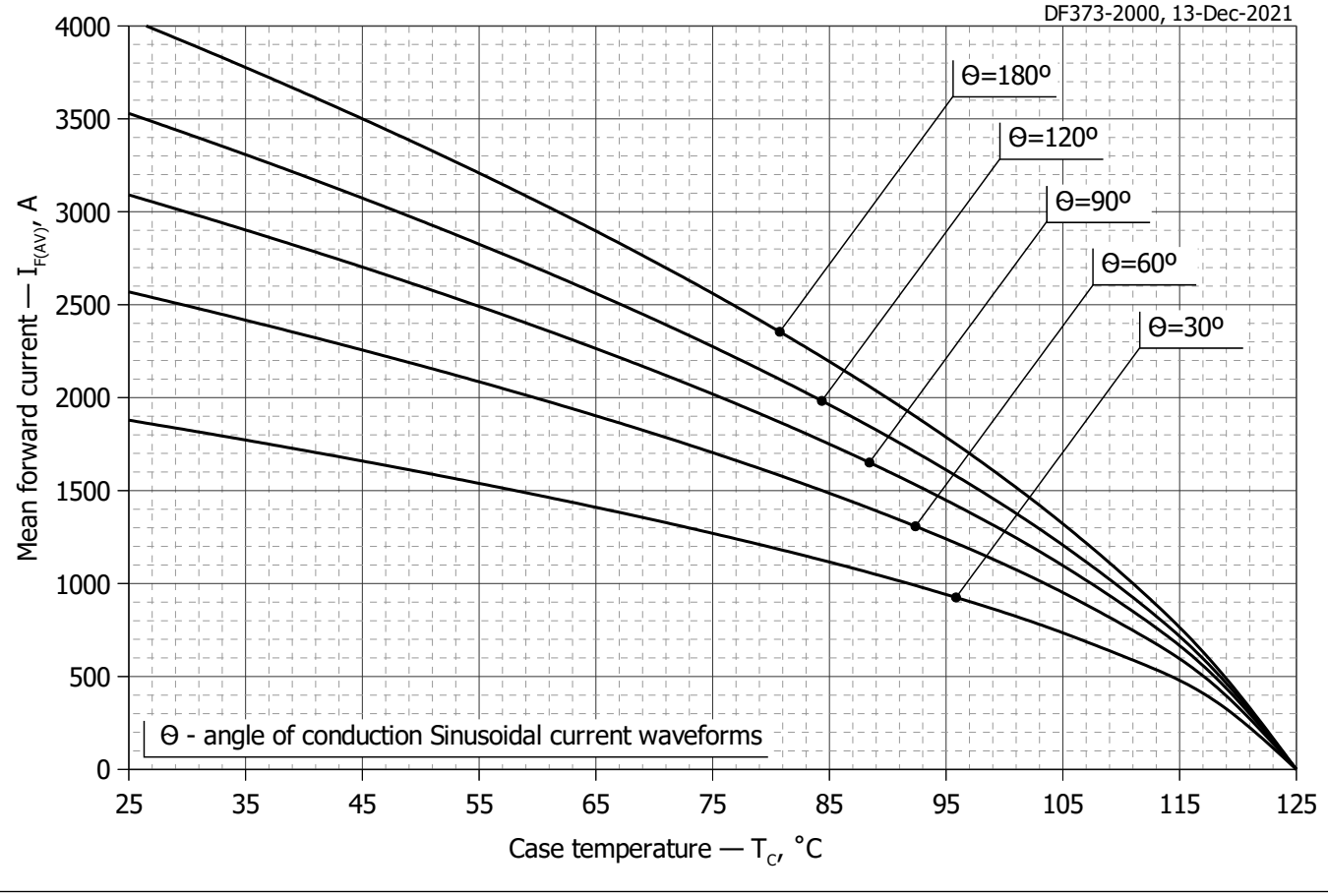


Fig. 9 – Mean forward current I_{FAV} vs. case temperature T_C for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

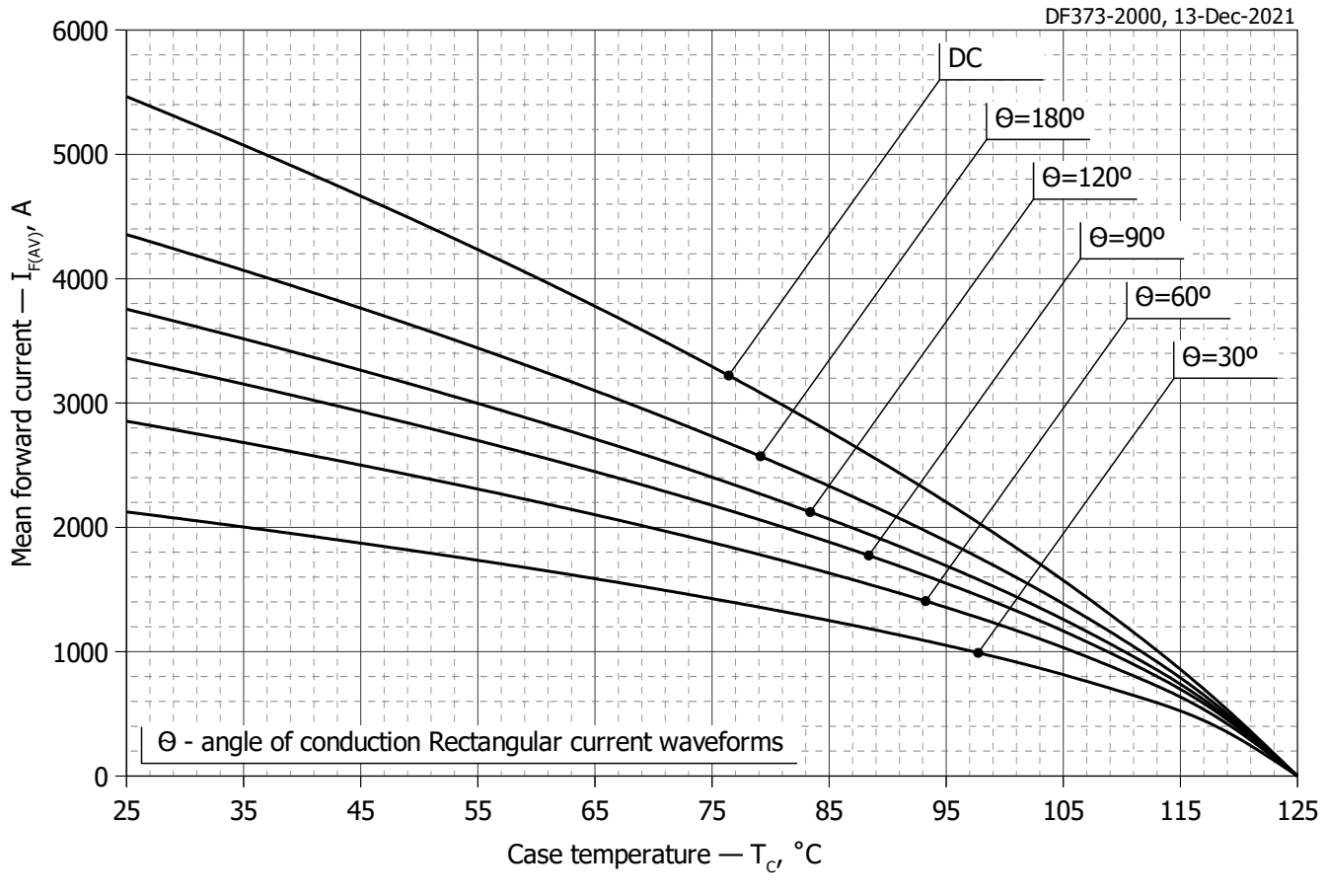


Fig. 10 - Mean forward current I_{FAV} vs. case temperature T_C for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

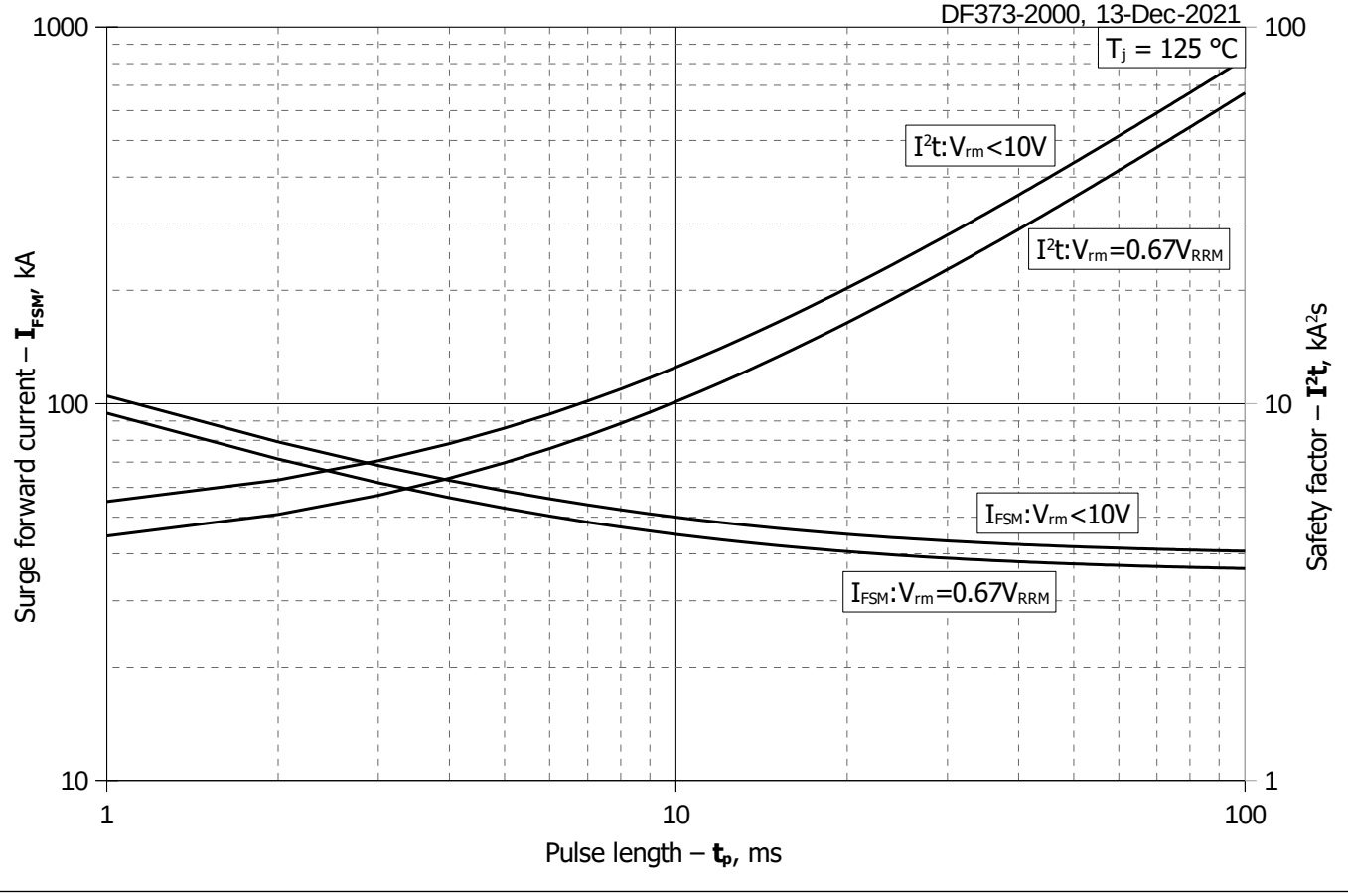


Fig. 11 – Maximum surge forward current I_{FSM} and safety factor I^2t vs. pulse length t_p

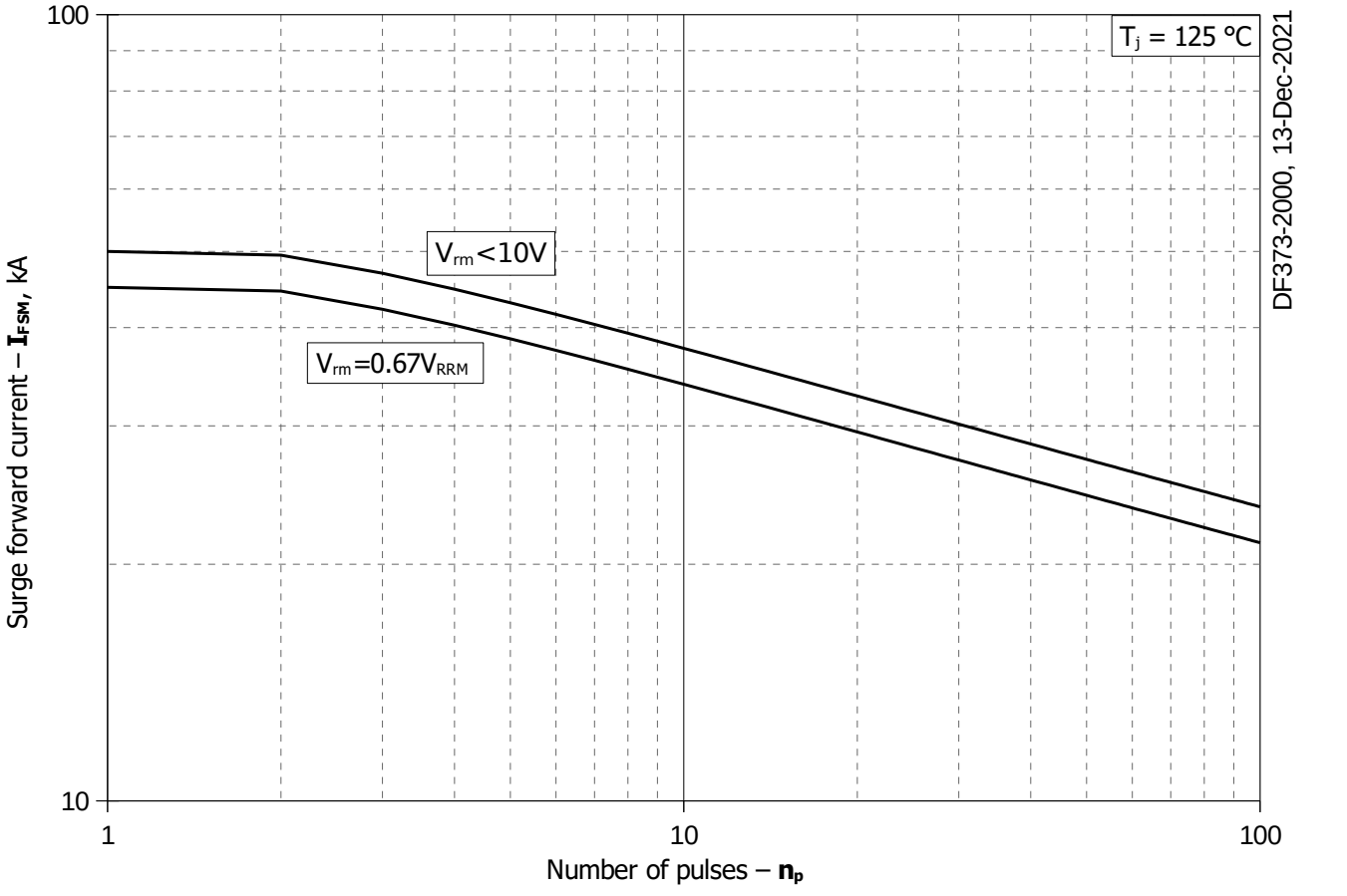


Fig. 12 - Maximum surge forward current I_{FSM} vs. number of pulses n_p